

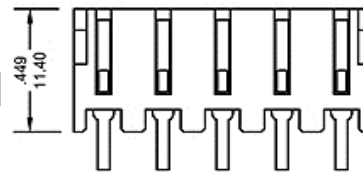
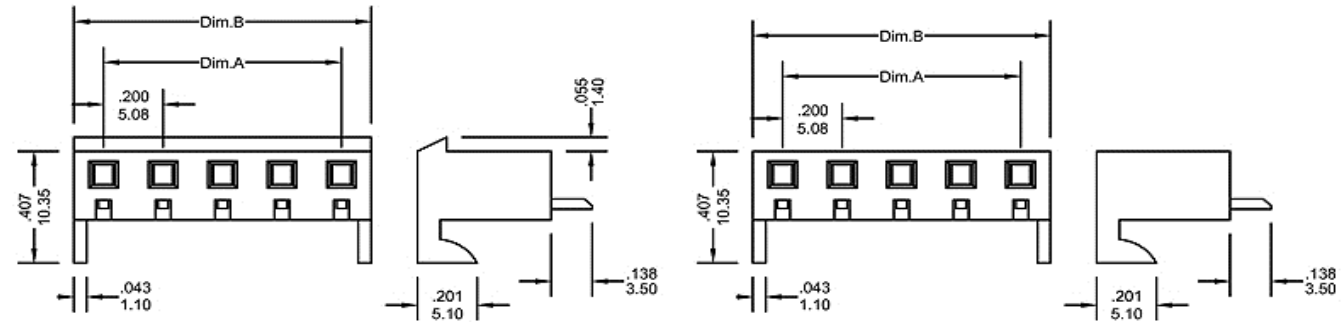
EDCON-COMPONENTS



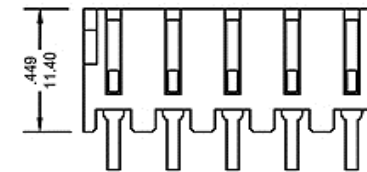
Specifications

Voltage Rating:	250 V AC/DC
Current Rating:	7A AC/DC
Operating Temperature:	-40°C to + 105°C
Contact Resistance:	10 mΩ
Withstanding Voltage:	1500 V AC/Minute
Insulation Resistance:	500MΩ min.
Material Housing:	Nylon 66 / UL94V-2
Pin-Material:	Copper Alloy / Tin-plated
Body Color:	Natural / White
Normal Force:	3,4N

Drawing (dimensions all into mm)

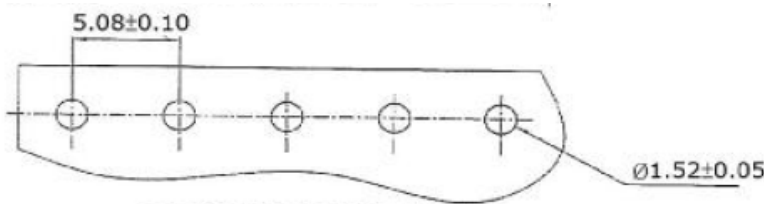


Y: With Locking Ramp



N: Without Locking Ramp

P.C.B. Layout



Wafer Serie T68D006 Pitch 5,08mm

Part No.: **T68D006**

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	21.12.2012
APPD:	Schumi			FINISH	Jamy		Sheet No.	1 from 4	Customer:

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Ordering Informations

Serie	Number of Pos.	Color of Body	Contact Plating	Locking Rip	Packing					
T68D006	02	NA	TN	Y	BU					
xx = Pos. Look table	NA= Natural	TN= Tin Alloy (100µ)min.	Y= with looking rip (Standard) N= without looking rip	BU= Bulk-ware						
	WH= White									

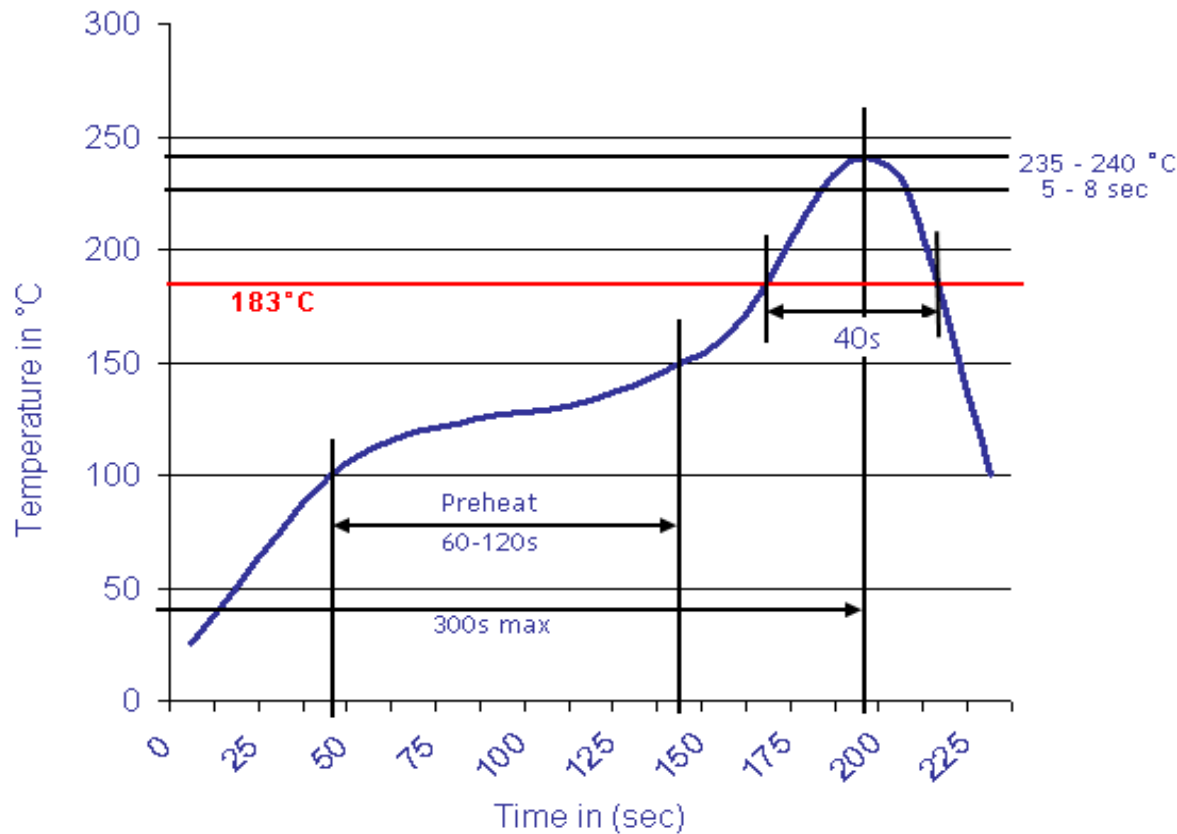
Wafer Serie T68D006 Pitch 5,08mm	
Part No.:	T68D006
Customer:	

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	21.12.2012
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Soldering Profile Curve

Classification Reflow Profile (JEDEC J-STD-020C)



Wafer Serie T68D006 Pitch 5,08mm
Part No.: T68D006
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